http://www.kamaya.co.jp KAMAYA OHM

SMD Product handling manual (RECOMMENDED SOLDERING CONDITION)

Note: This soldering condition is not supported by the mounting evaluation.

This is reference information only.

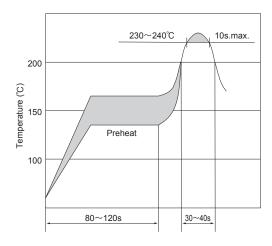
Application

All Kamaya Surface Mount Devices

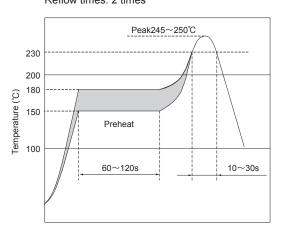
Recommended Soldering Condition (Reference)

- 1. Reflow soldering
 - 1.1 Recommended condition of Sn-Pb solder.

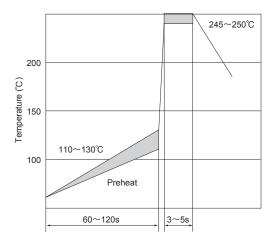
Reflow times: 2 times



1.2 Recommended condition of Sn solder Reflow times: 2 times



2. Flow soldering (Recommended condition of Sn solder and Sn-Pb solder)



- 3. Soldering Iron (Recommended condition of Sn solder and Sn-Pb solder)
 - (1) Temperature of soldering iron tip: 300°C, Duration: 10 s max.
 - (2) Temperature of soldering iron tip: 350°C, Duration: 3 s max.

Others

- (1) Please carry out enough mounting evaluation when use the profile except those above.
- (2) Please contact Kamaya sales dept. for further information.